



A 360° VIEW OF THE MOST INNOVATIVE  
TECHNOLOGY AND PROCESSES. **FABTECH 2013.**

**NOVEMBER 18–21, 2013**  
MCCORMICK PLACE | CHICAGO, IL  
[fabtechexpo.com](http://fabtechexpo.com)



Date: July 03, 2013

To: United States Embassy in China  
Subject: Visa Invitation to come to the United States

To Whom It May Concern:

On behalf of Tianjin Xinsen Welding Materials Co., Ltd, we hereby acknowledge XU XIANFENG's participation in FABTECH, to be held November 18 – 21, 2013 at McCormick Place, Chicago, IL (USA).

XU XIANFENG's registration ID number is 207415.

This is an official letter of invitation to the FABTECH event so that XU XIANFENG at Tianjin Xinsen Welding Materials Co., Ltd, can obtain his/her travel visa through the Embassy. An additional 3 days before and after the event are generally necessary to make preparation. XU XIANFENG will be responsible for all expenses once inside the United States.

First Name: XU  
Last Name: XIANFENG  
Passport Issue Date: 10/13/2009  
Passport Exp. Date: 10/12/2019  
Visa Company Name: Tianjin Xinsen Welding Materials Co., Ltd  
Company Address: Huyuan Industrial Area  
Shuangjie Town Beichen Dist  
Tianjin  
China  
Phone:  
dob: 06/21/1963

We look forward to welcoming XU XIANFENG to the United States to participate in this educational event organized by the American Welding Society, Fabricators & Manufacturers Association, Society of Manufacturing Engineers, Precision Metalforming Association, and Chemical Coaters Association. If you need further information please refer to the event website at [www.fabtechexpo.com](http://www.fabtechexpo.com)

Sincerely,

John Catalano  
Group Show Manager  
Society of Manufacturing Engineers  
PO Box 930  
Dearborn MI 48121-0930